

# New Jersey Semi-Conductor Products, Inc.

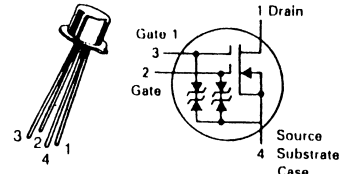
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**3N204**  
**3N205**

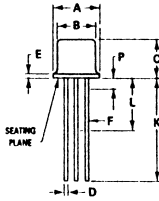
## MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	25	Vdc
Drain-Gate Voltage	$V_{DG}$	30	Vdc
Drain Current	$I_D$	50	mA
Reverse Gate Current	$I_G$	10	mA
Forward Gate Current	$I_{GF}$	10	mA
Total Device Dissipation (at $T_A = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$ )	$P_D$	360	mW
		2.4	mW/ $^\circ\text{C}$
Total Device Dissipation (at $T_C = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$ )	$P_D$	1.2	mW
		0.8	mW/ $^\circ\text{C}$
Lead Temperature	$T_L$	300	$^\circ\text{C}$
Operating and Storage Junction Temperature Range	$T_J, T_{stg}$	$-65^\circ\text{C}$ to $+175^\circ\text{C}$	$^\circ\text{C}$



## DUAL-GATE MOSFET

N-CHANNEL — DEPLETION  
 (TO-72) METAL



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	5.31	5.84	0.209	0.230
B	4.52	4.95	0.178	0.195
C	4.32	5.33	0.170	0.210
D	0.41	0.53	0.016	0.021
E	—	0.76	—	0.030
F	0.41	0.48	0.016	0.019
G	—	2.54 BSC	—	0.100 BSC
H	0.91	1.17	0.036	0.046
J	0.21	1.27	0.008	0.048
K	12.70	—	0.500	—
L	6.35	—	0.250	—
M	—	45 BSC	—	45 BSC
N	—	1.27 BSC	—	0.050 BSC
P	—	1.27	—	0.050

## ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Min	Max	Unit
<b>OFF CHARACTERISTICS</b>				
Drain-Source Breakdown Voltage ( $I_D = 10 \mu\text{A}, V_{G1} = V_{G2} = -5.0 \text{V}$ )	$V_{(BR)DSX}$	25	—	Vdc
Gate 1-Source Breakdown Voltage ( $I_{G1} = \pm 10 \text{mA}$ ) Note 1	$V_{(BR)G1S0}$	$\pm 6$	$\pm 30$	Vdc
Gate 2-Source Breakdown Voltage ( $I_{G2} = \pm 10 \text{mA}$ ) Note 1	$V_{(BR)G2S0}$	$\pm 6$	$\pm 30$	Vdc
Gate 1 Leakage Current ( $V_{G1S} = \pm 5.0 \text{V}, V_{G2S} = V_{DS} = 0$ )	$I_{G1SS}$	—	$\pm 10$	nA
Gate 2 Leakage Current ( $V_{G2S} = \pm 5.0 \text{V}, V_{G1S} = V_{DS} = 0$ )	$I_{G2SS}$	—	$\pm 10$	nA
Gate 1 to Source Cutoff Voltage ( $V_{DS} = 15 \text{V}, V_{G2S} = 4.0 \text{V}, I_D = 20 \mu\text{A}$ )	$V_{G1S(off)}$	-0.5	-4.0	Vdc
Gate 2 to Source Cutoff Voltage ( $V_{DS} = 15 \text{V}, V_{G1S} = 0 \text{V}, I_D = 20 \mu\text{A}$ )	$V_{G2S(off)}$	-0.2	-4.0	Vdc
<b>ON CHARACTERISTICS</b>				
Zero-Gate-Voltage Drain Current* ( $V_{DS} = 15 \text{V}, V_{G2S} = 4.0 \text{V}, V_{G1S} = 0 \text{V}$ )	$I_{DSS}^*$	6	30	mA
<b>SMALL-SIGNAL CHARACTERISTICS</b>				
Forward Transfer Admittance ( $V_{DS} = 15 \text{V}, V_{G2S} = 4.0 \text{V}, V_{G1S} = 0 \text{V}, f = 1.0 \text{kHz}$ ) Note 2	$ Y_{fs} $	10	22	mmhos
Input Capacitance ( $V_{DS} = 15 \text{V}, V_{G2S} = 4.0 \text{V}, I_D = I_{DSS}, f = 1.0 \text{MHz}$ )	$C_{iss}$	Typ. 3.0		pF
Reverse Transfer Capacitance ( $V_{DS} = 15 \text{V}, V_{G2S} = 4.0 \text{V}, I_D = 10 \text{mA}, f = 1.0 \text{MHz}$ )	$C_{rrs}$	0.005	0.03	pF
Output Capacitance ( $V_{DS} = 15 \text{V}, V_{G2S} = 4.0 \text{V}, I_D = I_{DSS}, f = 1.0 \text{MHz}$ )	$C_{oss}$	Typ. 1.4		pF
<b>FUNCTIONAL CHARACTERISTICS</b>				
Noise Figure ( $V_{DD} = 18 \text{V}, V_{GG} = 7.0 \text{V}, f = 200 \text{MHz}$ ) ( $V_{DS} = 15 \text{V}, V_{G2S} = 4.0 \text{V}, I_D = 10 \text{mA}, f = 450 \text{MHz}$ )	NF	—	3.5	dB
		—	5.0	
Common Source Power Gain ( $V_{DD} = 18 \text{V}, V_{GG} = 7.0 \text{V}, f = 200 \text{MHz}$ ) ( $V_{DS} = 15 \text{V}, V_{G2S} = 4.0 \text{V}, I_D = 10 \text{mA}, f = 450 \text{MHz}$ )	$G_{ps}$	20	28	dB
		14	—	
Bandwidth ( $V_{DD} = 18 \text{V}, V_{GG} = 7.0 \text{V}, f = 200 \text{MHz}$ ) ( $V_{DD} = 18 \text{V}, f_{LO} = 245 \text{MHz}, f_{RF} = 200 \text{MHz}$ ) (Note 4)	BW	7.0	12	MHz
		4.0	7.0	
Gain Control Gate-Supply Voltage (Note 3) ( $V_{DD} = 18 \text{V}, \Delta G_{PS} = 300 \text{dB}, f = 200 \text{MHz}$ )	$V_{GG(GC)}$	0	-2.0	Vdc
Conversion Gain (Note 4) ( $V_{DD} = 18 \text{V}, f_{LO} = 245 \text{MHz}, f_{RF} = 200 \text{MHz}$ )	$G_{(conv.)}$	17	28	dB



Quality Semi-Conductors